TOSHIBA

TOSHIBA Photocoupler Photo Relay

TLP227GA, TLP227GA-2

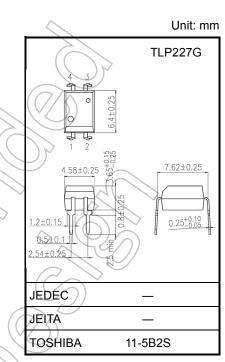
Modem Telecommunications PBXs

The Toshiba TLP227GA series consist of an infrared-emitting diode optically coupled to a photo-MOSFET in a 4-pin DIP or a 8-pin DIP package, and has a peak off-State voltage of 400 V.

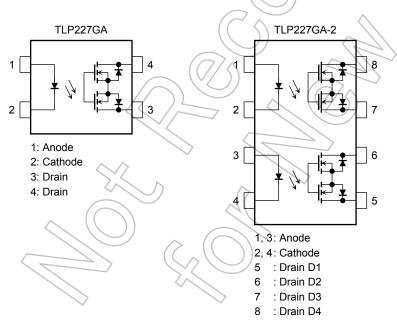
- Normally off function
- TLP227GA TLP227GA-2
- Peak off-state voltage : 4
- Trigger LED current
- On-state current
- On-state resistance
- Isolation voltage
- UL-recognized
- cUL-recognized

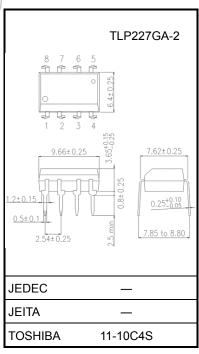
- : DIP4 (1 form A) : DIP8 (2 form A)
- : 400 V (min)
- : 3 mA (max)
 - : 120 mA (max)
 - : 35 Ω (max)
 - : 2500 Vrms (min)
 - : UL 1577, File No.E67349
 - : CSA Component Acceptance Service No.5A File No.E67349





Weight: 0.26 g (typ.)





Weight: 0.54 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

		Characteristic	5	Symbol	Rating	Unit
	Forward current			lF	50	mA
	Forward current derating (Ta ≥ 25°C)			∆l _F /°C	-0.5	mA/°C
7	Peak forward current (100 μs pulse, 100 pps)			IFP	1	А
Led	Reverse volt	age		VR	5	V
	Diode power	dissipation		PD	50	mW
	Diode power	dissipation der	ating (Ta ≥25°C)	∆P _D /°C	-0.5	_mW/°C(
	Junction tem	Junction temperature			125	ç
	Off-state out	put terminal vol	tage	Voff	400	
		TLP227GA		ION	120	
	On-state current	TLP227GA-2	One channel			mA
			Both channel		\bigcirc	$\langle \rangle$
	On-state	TLP227GA) <
Detector	current rating (Ta ≥ 25°C)	TLP227GA-2	One channel	∆lon/°C	-1.2	mA/°C
Dete			Both channel			
	Output power dissipation		TLP227GA	- Po	432	mW
			TLP227GA-2		600	
	Output power dissipation		TLP227GA	APo/°C	-4.32	mW/°C
	derating (Ta	derating (Ta ≥ 25°C) TLP227GA-2			-6,0	
	Junction tem	perature	C	्त	125	°C
Sto	rage temperat	age temperature range			-55 to 125	°¢
Эре	erating temper	ature range	C	Topr	-40 to 85	°C
Lea	d soldering te	mperature (10 s	s)	T _{sol}	260	°C
Isol	ation voltage (AC, 60 s, R.H.	≤ 60 %) (Note 1)	BVs	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: LED pins are shorted together. Detector pins are also shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V _{DD}	-	—	320	V
Forward current	lF	5	7.5	25	mA
On-state current	I _{ON}	_	—	100	mA
Operating temperature	T _{opr}	-20	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μA
	Capacitance	Ст	VF = 0 V, f = 1 MHz	/	30	_	pF
Detector	Off-state current	IOFF	Voff = 400 V		2	1	μΑ

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	IFT	ION = 120 mA	- ~		3	mA
On-state resistance	Ron	Ion = 120 mA, IF = 5 mA	4	18	35	Ω

Isolation Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	Vs = 0 V, f = 1 MHz	<u> </u>	0.8	_	pF
Isolation resistance	Rs	Vs = 500 V, R.H. ≦ 60 %	5 × 10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVs	AC, 60 s	2500		I	Vrms

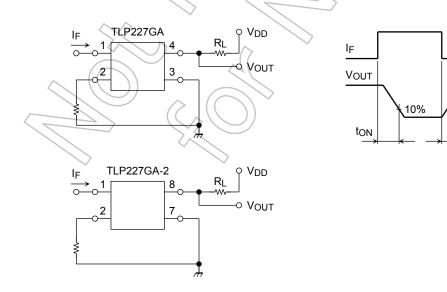
Switching Characteristics (Ta = 25°C)

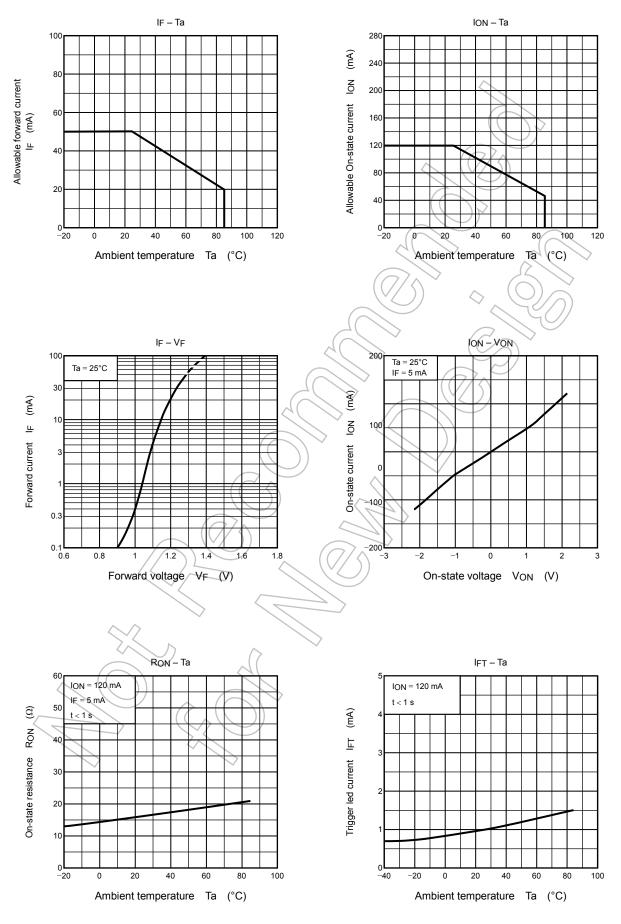
Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	ton	RL = 200 Ω		Ι	-	1	m 0
Turn-off time	toff	$V_{DD} = 20 V, I_F = 5 mA$ (No	ote 2)	_	_	1	ms

90%

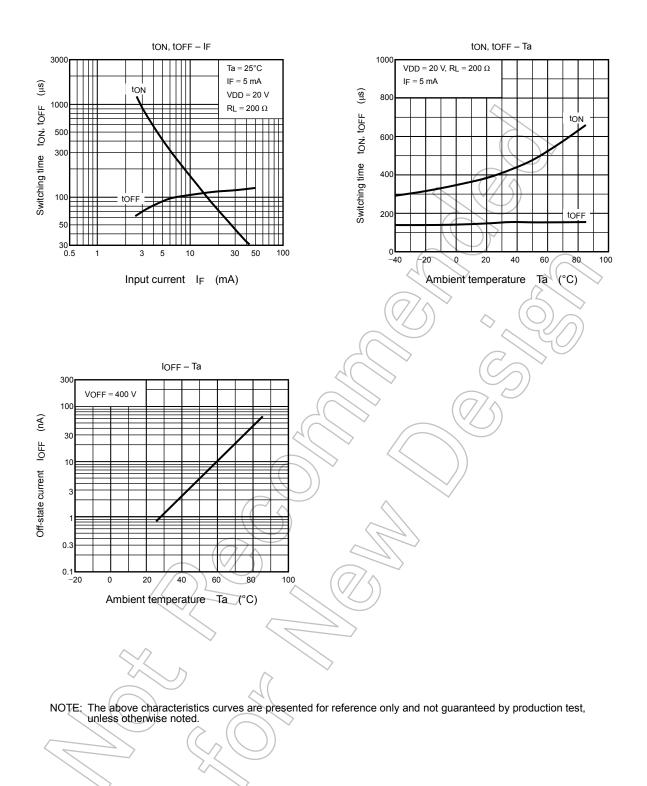
toff

Note 2: Switching time test circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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